# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YONG LI	09/22/2016
ZHONGSHAN HONG	09/22/2016

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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15275111

## **CORRESPONDENCE DATA**

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PATENT REEL: 039849 FRAME: 0110

NAME OF SUBMITTER:	AKIKO YOSHIDA
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DATE SIGNED:	09/23/2016
Total Attachments: 2	

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> **PATENT REEL: 039849 FRAME: 0111**

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# ASSIGNMENT AND DECLARATION

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PATENT REEL: 039849 FRAME: 0112 SMIC 2015-00875-SH-US Anova Law Group, PLLC 00158.0366.00US

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If the application is not attached hereto, the application is as identified above or by the attorney docket number as set forth above and/or the following.

The above-identified application was made or authorized to be made by me.

Further, as a below named inventor, I hereby declare that:

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37,Code of Federal Regulations § 1.56, including for continuation-in-part applications, material information which became available between the filing data of the prior application and the national or PCT International filing date of the continuation-in-part application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor 1 YONG LI Legal Name:

Signature: な鬼 /og Li Date: Jo16-9-22

Inventor 2 ZHONGSHAN HONG Legal Name: کا

Signature: Zhongshan Hong Date: 2016-9-22

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form or must have been previously filed. Check the box below and complete the attached page(s) to list additional inventors.

Additional inventors are being named on the \_\_\_supplemental sheet(s) attached hereto.

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